

# U.S. UTILITY Patent Application

SCANNED *PRO.I.P.E.* *AK2* *QA* *6c*

PATENT DATE

APPLICATION NO.  
09/903114

CONT/PRIOR  
D

CLASS  
427

SUBCLASS  
58

ART UNIT  
1762

EXAMINER

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Thermal processing system and methods for forming low-k dielectric films suitable for incorporation into microelectronic devices

PTO-2040  
12/99

## ISSUING CLASSIFICATION

ORIGINAL		CROSS REFERENCE(S)					
CLASS	SUBCLASS	CLASS	SUBCLASS (ONE SUBCLASS PER BLOCK)				
INTERNATIONAL CLASSIFICATION							

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<input type="checkbox"/> <b>TERMINAL DISCLAIMER</b>  <input type="checkbox"/> The term of this patent subsequent to (date) has been disclaimed.  <input type="checkbox"/> The term of this patent shall not extend beyond the expiration date of U.S. Patent No. _____  <input type="checkbox"/> The term of this patent shall not extend beyond the expiration date of U.S. Patent No. _____	<b>DRAWINGS</b> Sheets Drawg. Figs. Drawg. Print Fig.			<b>CLAIMS ALLOWED</b> Total Claims: _____ Print Claim for O.G. _____	
	(Assistant Examiner) (Date)			<b>NOTICE OF ALLOWANCE MAILED</b> _____ _____ _____	
	(Primary Examiner) (Date)			<b>ISSUE FEE</b> Amount Due: _____ Date Paid: _____	
	(Legal Instruments Examiner) (Date)			<b>ISSUE BATCH NUMBER</b> _____	

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